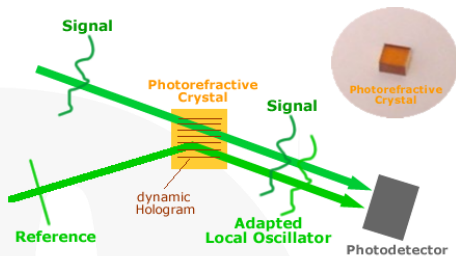


TEMPO 1D ULTRA-HIGH FREQUENCY RECEIVER

Laser
Ultrasonics

TECHNOLOGY

The **Tempo 1D** receiver is based on photorefractive two-wave mixing. A dynamic hologram resulting from the interferences between the reference beam and the signal beam is recorded in the photorefractive crystal. The diffraction of the reference beam by the dynamic hologram creates a local oscillator adapted to the signal i.e. same wavefront and same direction. Two-wave mixing in a photorefractive material is equivalent to an adaptive beam splitter. The two beams – signal and adapted local oscillator – are in perfect quadrature and are incident on the photodetector that delivers a homodyne signal.



High performances photorefractive crystals are used with reliable properties to insure an optimum two-wave mixing process. A high voltage field is applied on the photorefractive crystal in order to optimize the coupling and maintain the quadrature between the signal and the diffracted reference (adapted local oscillator). Photorefractive two-wave mixing has been extensively studied over the past 40 years and is a well-developed process.

FEATURES

- > No high frequency limit
- > Large étendue interferometer
- > High sensitivity on all surface types and materials
- > Continuous detection laser

EXAMPLES OF APPLICATIONS

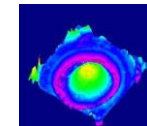
Material Characterization

Laser-ultrasonics are used to measure fundamental material properties such as the elastic modulus, shear modulus and Poisson ratio. Those parameters are of great importance for estimation of active stresses and life service

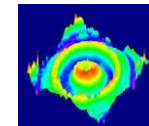
Transducer characterization



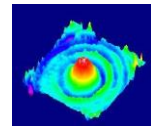
1 MHz piezo, 1 inch Φ
1 μ s pulse excitation



Sample surface at t_0



At $t_0+1 \mu$ s




At $t_0+2 \mu$ s


Acoustic emission

The laser receiver can also be used independently, without the generation laser, to listen to acoustic emissions occurring when the sample is under stress. Remote detection of acoustic emission can be used for monitoring during manufacturing processes.

SPECIFICATIONS



Technology
Two-Wave mixing


Detection
Out-Of-Plane



Configuration
Free-Space



Internal Laser power
Up to 1.5 W @532nm


NESD (out-of-plane motion)
 2.10^{-7} nm. (W/Hz)^{1/2}


Detection bandwidth
Up to 1Ghz


Dimensions
492 x 302 x 114 mm³


Weight
16kg


Electrical requirements
110V / 220V
50Hz / 60Hz